

RFP: Empanelment of Technical Service Provide (TSP) vendor -

RFP NO: CO: BFSL/ SYS RFP/2023-24/06, RFP Dated: 30th Oct, 2023.

Addendum 1, Dated 09th NOV, 2023.

- **Pre-bid meeting will be conducted online through Microsoft team meeting.**
- **Please find the below link to join in the Pre-Bid Meeting.**
- https://teams.microsoft.com/l/meetup-join/19%3ameeting_ODIyNjk2YjAtYmU4Mi00YThkLTk5OTktY2M2OTU4YTdhZWZm%40thread.v2/0?context=%7b%22Tid%22%3a%22048b0a7a-d7c6-4384-a7f0-3f07940a2038%22%2c%22Oid%22%3a%22574bb1fd-d2bd-4ffb-8545-929f746b6207%22%7d
- Meeting ID: 496 238 369 327
- Passcode: WRNxYV

S/D

Authorized Signatory